

# Process Modeling of Micro-Cutting Including Strain Gradient Effects

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#### **Presentation Outline**

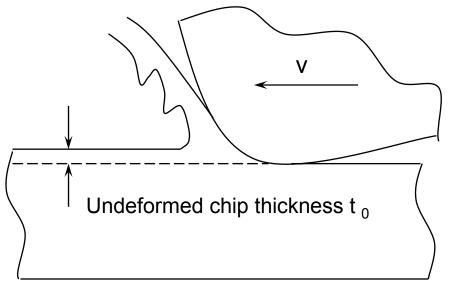


- Characteristics of micro-cutting
- Research objectives
- Numerical modeling of micro-cutting process
- Strain gradient plasticity
- Initial results
- Future work

#### Typical Characteristics of Micro-Cutting Process

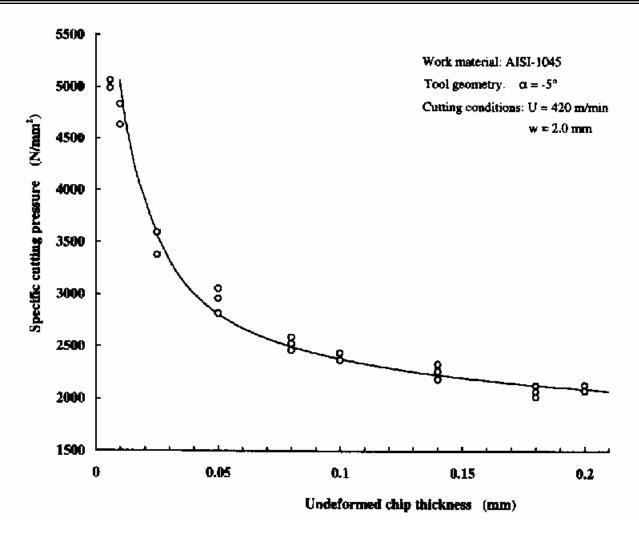


- Very small undeformed chip thickness (1 μm~100 μm)
- Tool edge geometry dimension comparable to undeformed chip thickness.
- Large negative rake angle
- Large shear strain, strain gradient in primary shear zone.



## Size effect in machining





#### Research Objectives



- Develop a computational model to describe the micro-cutting process, taking into account the size effect.
- Predict the stresses, strains, temperatures, cutting forces and residual stresses in the micro-mechanically machined workpiece.
- Experimentally verify model.

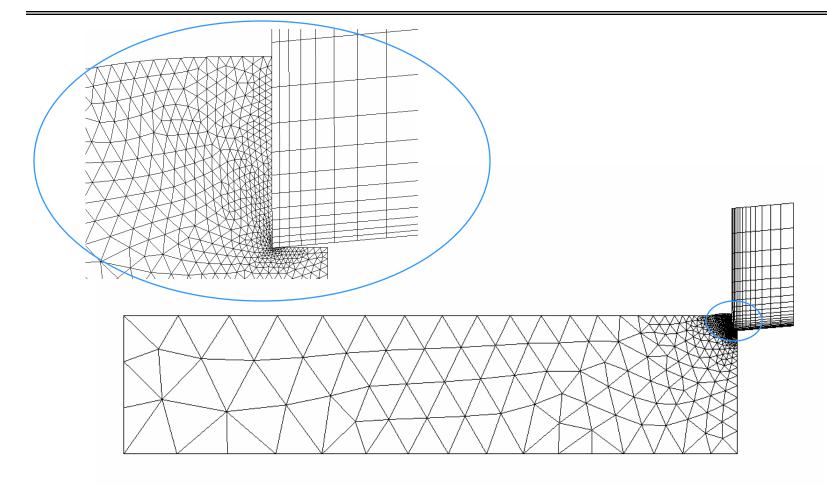
#### Essential Model Capabilities



- Fully coupled thermal-mechanical analysis
- Accurate material flow stress modeling
- Physically-based chip separation criterion
- Adaptive remeshing capability
- Fracture initiation and crack growth
- Friction characteristics

# Finite Element Model Configuration





#### Strain Gradient Plasticity

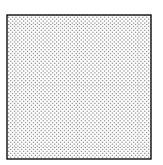


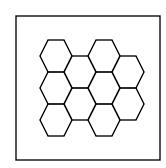
Classical Plasticity

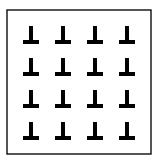
Strain gradient Plasticity

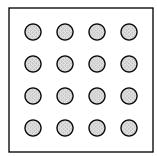
Dislocation Mechanics

Molecular Dynamics









Min. Length Scale L Macroscale

 $O(10^{-3}m)$ 

Polycrystal

 $O(10^{-5}m)$ 

0.1 μm~10 μm

Discrete Dislocations O(10<sup>-8</sup>m)

Atomistic

 $O(10^{-10}m)$ 

### Strain Gradient Plasticity



$$E = \frac{1}{2} \left( F^T \cdot F - 1 \right)$$

Green strain tensor E

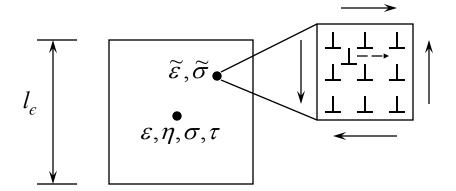
$$\eta_{ijk} = E_{ik,j} + E_{jk,i} - E_{ij,k}$$

Strain gradient tensor ŋ

$$\tau = \alpha \mu b \sqrt{\rho_s + \rho_g} \qquad \overline{\sigma} = \sigma_y \sqrt{f^2(\overline{\varepsilon}) + l\overline{\eta}} \qquad l = 3\alpha^2 \left(\frac{\mu}{\sigma_y}\right)^2 b$$

$$\overline{\sigma} = \sigma_y \sqrt{f^2(\overline{\varepsilon}) + l\overline{\eta}}$$

$$l = 3\alpha^2 \left(\frac{\mu}{\sigma_y}\right)^2 b$$

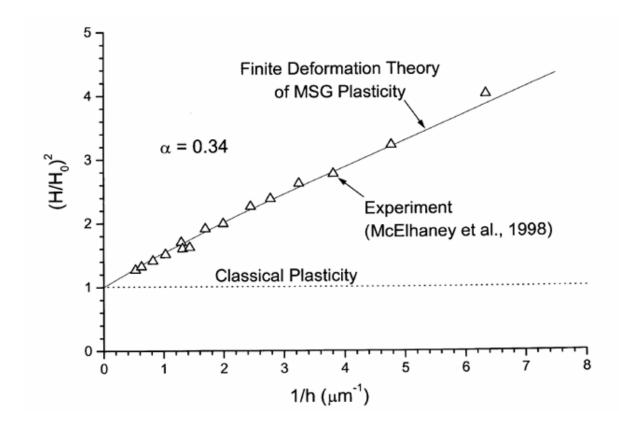


microscale  $\widetilde{\varepsilon}, \widetilde{\sigma}$ 

 $\mathcal{E}, \eta, \sigma, \tau$ mesoscale

# Strain Gradient vs. Classical Plasticity: Nanoindentation Example





### Machining / Indentation Analogy



Indentation

Machining

$$\gamma \approx 0.36$$

$$\gamma \approx 2 \sim 4$$

$$\eta = 4\gamma/D$$

$$\eta \approx 4\gamma/t$$

Hardness or Specific force

$$H = C'Gb\sqrt{\rho_s + (4\gamma/bD)}$$

$$F \approx AGb\sqrt{\rho_s + (4\gamma/bt)}$$

Characteristic length
Of deformation field

Indentation dimameter,D

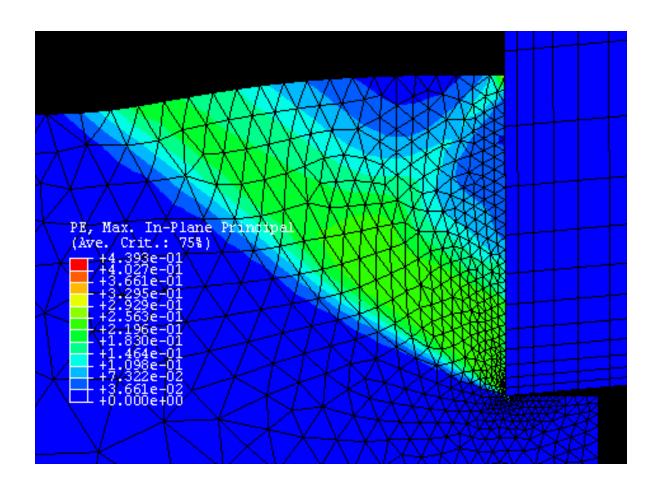
Undeformed chip thickness, t<sub>0</sub>

0.1 μm~10 μm

0.5 μm~50 μm

#### Initial Results





#### **Future Work**



- Implement strain gradient plasticity in finite element model
- Validate model by micro-/nano-indentation and/or microcutting experiment data